

N-Channel Enhancement Mode Field Effect Transistor

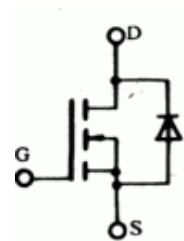
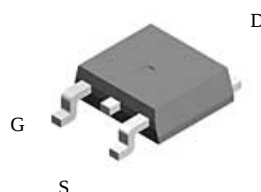
FEATURES

- Super high dense cell design for low $R_{DS(ON)}$
- Rugged and reliable
- Simple drive requirement
- TO-252 package



NOTE: The MT3055 is available in a lead-free package

PRODUCT SUMMARY		
V_{DSS}	I_D	$R_{DS(ON)}$ (m Ω) Typ
25V	15A	55@ $V_{GS}=4.5V$
		60@ $V_{GS}=2.5V$



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	25	V
Gate-Source Voltage	V_{GS}	± 16	V
Drain Current-Continuous ^a @ $T_j=125^\circ\text{C}$	I_D	15	A
- Pulse ^d	I_{DM}	48	A
Drain-source Diode Forward Current ^a	I_S	1.7	A
Maximum Power Dissipation ^a	P_D	55	W
Operating Junction and Storage Temperature Range	T_j, T_{STG}	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to Ambient ^a	$R_{th JA}$	50	$^\circ\text{C/W}$
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ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V,I _D =-250μA	25			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V			1	μA
Gate-Body Leakage	I _{GSS}	V _{GS} =±16V,V _{Ds} =0V			±100	nA
ON CHARACTERITICS						
Gate Threshold Voltage	V _{GS} (th)	V _{DS} =V _{GS} ,I _D =-250μA	0.8	1.1	2.0	V
Drain-Source On-State Resistance	R _{DS} (ON)	V _{GS} =10V,I _D =8A		50	65	m Ω
		V _{GS} =4.5V,I _D =5.0A		60	85	
Forward Transconductance	g _{FS}	V _{GS} =5V,I _D =5A		5		S
DAYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{DS} =10V,V _{GS} =0V f=1.0MHz		586		pF
Output Capacitance	C _{OSS}			101		pF
Reverse Transfer Capacitance	C _{RSS}			59		pF
SWITCHING CHARACTERISISTICS						
Turn-On Delay Time	t _D (ON)	V _{DD} =10V I _D =15 A, V _{GEN} =4.5V R _L =10ohm R _{GEN} =10ohm		6.5		ns
Rise Time	t _r			32.1		ns
Turn-Off Delay Time	t _D (OFF)			58.4		ns
Fall Time	t _f			48		ns
Total Gate Charge	Q _g	V _{DS} =10V,I _D =1A V _{GS} =4.5V		6		nC
Gate-Source Charge	Q _{gs}			1.35		nC
Gate-Drain Charge	Q _{gd}			1.5		nC

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ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=1.25A$		0.84	1.2	V

Notes

- Surface Mounted on FR4 Board, $t \leq 10\text{sec}$
- Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty $\leq 2\%$
- Guaranteed by design, not subject to production testing.

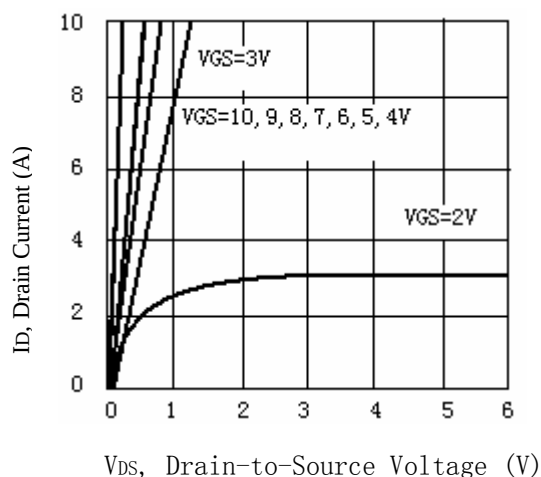


Figure 1. Output Characteristics

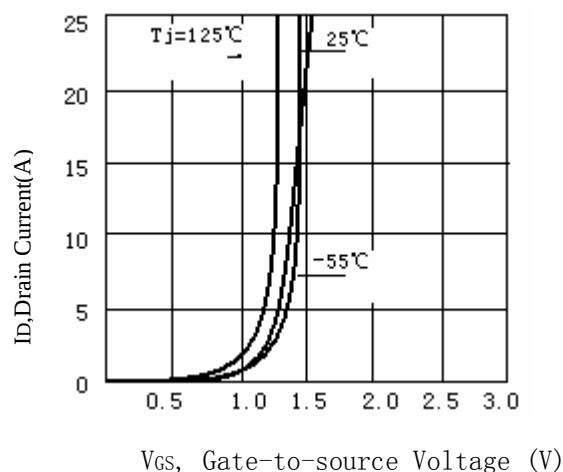


Figure 2. Transfer Characteristics

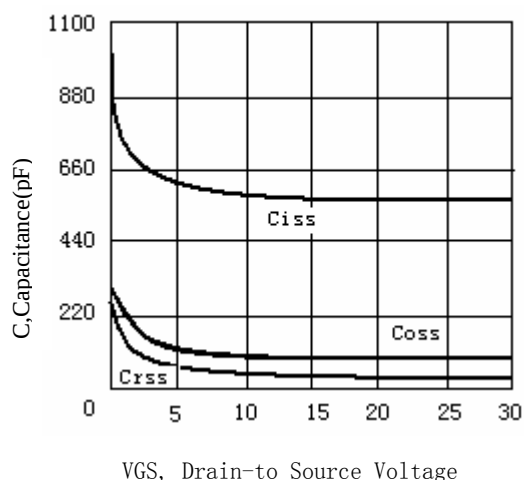


Figure 3. Capacitance

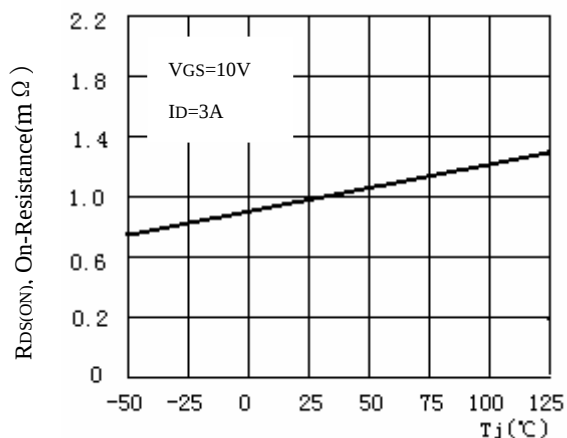
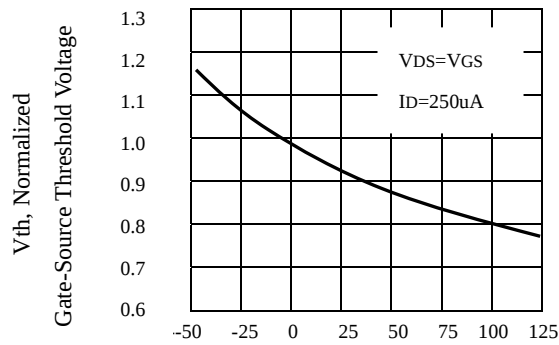
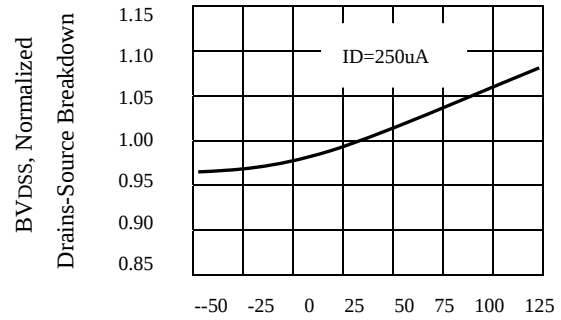


Figure 4. On-Resistance Variation with Temperature

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Tj, Junction Temperature(°C)
Figure5. Gate Threshold Variation
With Temperature



Tj, Junction Temperature (°C)
Figure6. Breakdown Voltage Variation
With Temperature

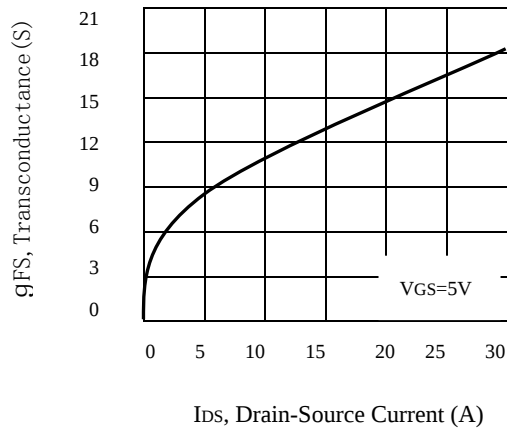


Figure7. Transconductance Variation
With Drain Current

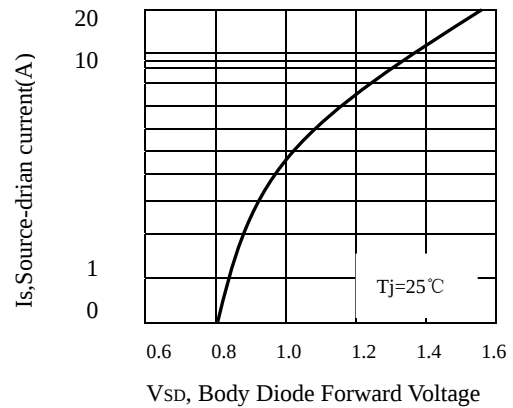


Figure8. Body Diode Forward Voltage
Variation with Source Current

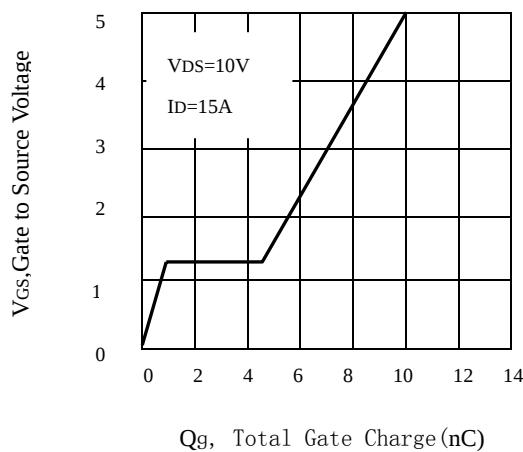


Figure9. Gate Charge

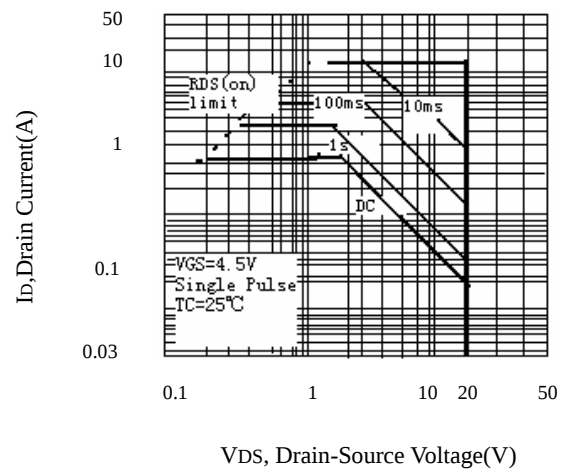


Figure10. Maximum Safe Operating Area